

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6	("4954875" "5229647" "6429509"). PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 21:55
L2	81	("2627545" "2734154" "3197766" "3475660" "3561110" "3648131" "3769702" "3813773" "3858958" "3867759" "3904934" "3967162" "3999105" "4029375" "4037246" "4050756" "4129881" "4295700" "4368106" "4394712" "4437109" "4499655" "4509099" "4558396" "4574331" "4581679" "4596069").PN. OR ("4954875"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L3	88	("3679941" "3691628" "3702025" "3769702" "3813773" "3999105" "4300153" "4426773" "4525921" "4612083" "4613891" "4646128" "4659931" "4672737" "4677528" "4703170" "4706166" "4761681" "4764846" "4783695" "4801992" "4803595" "4807021" "4827327" "4835593" "4862249" "4894706" "4897708" "4901136" "4907128" "4939568" "4941033" "4954875" "4956694" "4956695" "4956746" "4959749" "4983533" "4989063" "4996583" "5006923" "5013687" "5019943" "5025306" "5028986" "5032896" "5055425" "5093708" "5104820" "5111278" "5117282" "5128831" "5135556" "5138437" "5138438" "5172303" "5191404" "5191405" "5198888" "5200300" "5202754" "5221642" "5222014" "5229647" "5231304" "5247423". "5259110" "5270261" "5270571" "5283107" "5311401" "5330359").PN. OR ("5657206"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L4	620	redistribution adj layer	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L5	448	redistribution adj layer and "257"/\$. ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L6	1	"6856009".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L7	1	"20050067711".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55

L8	2	"6856009".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 21:55
L9	2	"5872337".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 21:55
L10	27	interposer with metal with traces	USPAT	OR	ON	2005/10/15 21:55
L11	2	("5371407" "5625222").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L12	1	"6573609".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L13	1	"6404,046".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L14	1	"5912507".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L15	1	"5834799".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L16	0	harper and redistribut\$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L17	0	Elenius and redistribut\$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L18	157	Elenius	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L19	115	Elenius and pad	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L20	108	Elenius and pad	USPAT	OR	ON	2005/10/15 21:55
L21	48	("2890395" "3255511" "3397278" "3493820" "3648131" "4023197" "4246595" "4257061" "4286374").PN. OR ("4613891"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L22	6	("20020127768" "4613891" "6127629" "6207903" "6303986" "6359333").PN. OR ("6696645"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L23	1	"20050067711".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55

L24	40	("4400870" "4582210" "4833102" "4897508" "5420419" "5528452" "5585311" "5729019" "5865417" "5895233").PN. OR ("6359333"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L25	0	"andujar.xa"	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L26	141	andujar.xa.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L27	41	("5071792" "5138434" "5229647" "5266912" "5485039" "5686317" "5851911" "5888883" "5893725" "5897337" "5904546" "6013948" "6060373" "6080602" "6087845" "6107109" "6107164" "6114240" "6130111" "6136137" "6150717" "6153448" "6169329" "6177295" "6180504" "6221751" "6233185" "6281131" "6294837" "6313531" "6326698" "6338980" "6350664" "6353267" "6379999" "6524890" "6534387" "6579748" "6589855" "6607970" "6649445").PN. OR ("6903442").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L28	88	("5046239" "5063177" "5172050" "5229647" "5236551" "5249450" "5404044" "5420520" "5426072" "5483741" "5487999" "5528080" "5541525" "5557844" "5578526" "5592736" "5607818" "5633122" "5634267" "5674785" "5686317" "5716218" "5781022" "5783461" "5783865" "5796590" "5801452" "5815000" "5834945" "5869974" "5876580" "5878485" "5896036" "5915977" "5929647" "5931685" "5936847" "5952840" "5962921" "6013948" "6040702" "6107109" "6107119" "6114240" "6162997").PN. OR ("6294837"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55

L29	58	("4899921" "5138434" "5299092" "5437915" "5495667" "5543658" "5686317" "5851911" "5888883" "5897337" "6060373" "6080602" "6087845" "6097087" "6107109" "6114240" "6118179" "6130111" "6153448" "6169329" "6177295" "6221751" "6233185" "6235554" "6252299" "6271056" "6281131" "6294837" "6303981" "6303997" "6310390" "6313531" "6314013" "6326242" "6326698" "6330158" "6338980" "6340845" "6359456" "6362529" "6368896" "6368930" "6372624" "6384487" "6400172" "6440772" "6441483" "6451624" "6465877" "6472735" "6482576" "6482674" "6501165" "6506625" "6507114" "6577013" "6582992" "6614104").PN. OR ("6841883"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L30	1	"5,229,647".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/15 21:55
L31	2362	(257/774).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:01
L32	1342	(257/780).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:01
L33	0	(257/7698).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:01
L34	1525	(257/698).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:02
L35	1679	(257/700).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:02

L36	865	(438/629).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:02
L37	2117	(438/614).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/15 22:02
L38	8903	31 32 34 35 36 37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:02
L39	5096	38 and (via hole throughole plug) same (semiconductor silicon wafer die integrated adj circuit IC)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:06
L40	3195	39 and (insulating dielectric non near2 conductive) near2 (film coat layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:05
L41	1443	31 and (via hole throughole plug) same (semiconductor silicon wafer die integrated adj circuit IC)and (insulating dielectric non near2 conductive) near2 (film coat layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:05
L42	1692	31 and (insulating dielectric non near2 conductive) near2 (film coat layer)and (insulating dielectric non near2 conductive) near2 (film coat layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:06
L43	1443	31 and (insulating dielectric non near2 conductive) near2 (film coat layer) and(via hole throughole plug) same (semiconductor silicon wafer die integrated adj circuit IC)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:06
L44	3195	38 and (via hole throughole plug) same (semiconductor silicon wafer die integrated adj circuit IC) and (insulating dielectric non near2 conductive) near2 (film coat layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:07

L45	1865	38 and (via hole throughole plug) with connect\$3 with (top with bottom surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:08
L46	410	45 and (via hole throughole plug) with size	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:09
L47	410	45 and (via hole throughole plug) with size	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/15 22:09
L48	314	45 and (via hole throughole plug) with size	USPAT	OR	ON	2005/10/15 22:09